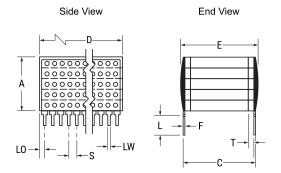
KEMET Part Number: L1WN30C565KS24



KPS LDD Comm SMPS, Ceramic, 5.6 uF, 10%, 500 VDC, X7R, N/A



Dimensions	
D	25.715mm +/-1.585mm
L	6.35mm MIN
Т	1.397mm MAX
S	2.54mm TYP
F	0.254mm +/-0.051mm
Α	6.096mm MAX
С	11.43mm +/-0.635mm
E	12.7mm NOM
G	1.4mm +/-0.25mm
LO	1.586mm MAX
LW	0.508mm +/-0.051mm

Packaging Specifications		
Packaging:	Waffle, Box	
Packaging Quantity:	28	

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General Information		
Series:	KPS LDD Comm SMPS	
Style:	Leaded Stacked Chip	
Description:	Low ESR, High Current Stacked Ceramic Chips	
Features:	Low ESR, High Current, High Performance	
RoHS:	No	
Prop 65:	WARNING: Cancer and reproductive harm - www.p65warnings.ca.gov.	
SCIP Number:	4221181d-d71c-4d0a- af45-5eab760732b2	
Termination:	60/40 Solder Coated	
Lead:	Wire Leads	
Failure Rate:	N/A	
Testing and Reliability:	Commercial	
AEC-Q200:	No	
Notes:	Note: Number of chips in stack depends on design. Number of Chips in this stack = 2. Note: Lead alignment within pin rows shall be within ±.0.13 mm.	

Specifications		
Capacitance:	5.6 uF	
Capacitance Tolerance:	10%	
Voltage DC:	500 VDC	
Dielectric Withstanding Voltage:	750 VDC	
Temperature Range:	-55/+125°C	
Temperature Coefficient:	X7R	
Dissipation Factor:	2.5% 1 kHz 25C	
Aging Rate:	3% Loss/Decade Hour	
Insulation Resistance:	17.9 GOhms	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.



单击下面可查看定价,库存,交付和生命周期等信息

>>KEMET(基美)